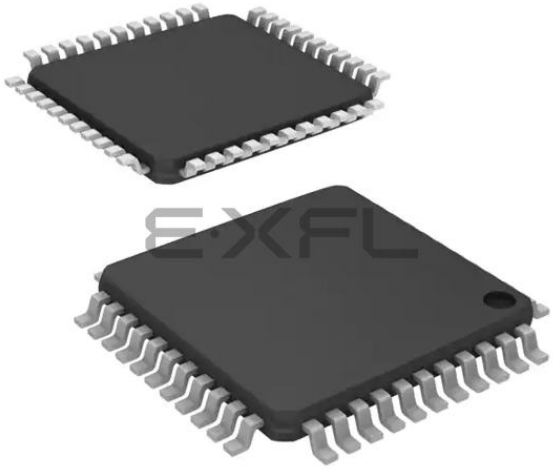

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Details	
Product Status	Active
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Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c44-33-pt

4.1.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides a 1024 oscillator cycle (1024TOSC) delay after $\overline{MCLR}$ is detected high or a wake-up from SLEEP event occurs.

The OST time-out is invoked only for XT and LF oscillator modes on a Power-on Reset or a Wake-up from SLEEP.

The OST counts the oscillator pulses on the OSC1/CLKIN pin. The counter only starts incrementing after the amplitude of the signal reaches the oscillator input thresholds. This delay allows the crystal oscillator or resonator to stabilize before the device exits reset. The length of time-out is a function of the crystal/resonator frequency.

4.1.4 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First the internal POR signal goes high when the POR trip point is reached. If $\overline{MCLR}$ is high, then both the OST and PWRT timers start. In general the PWRT time-out is longer, except with low frequency crystals/resonators. The total time-out also varies based on oscillator configuration. Table 4-1 shows the times that are associated with the oscillator configuration. Figure 4-2 and Figure 4-3 display these time-out sequences.

If the device voltage is not within electrical specification at the end of a time-out, the $\overline{MCLR}$/VPP pin must be held low until the voltage is within the device specification. The use of an external RC delay is sufficient for many of these applications.

TABLE 4-1: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up	Wake up from SLEEP	$\overline{MCLR}$ Reset
XT, LF	Greater of: 96 ms or 1024TOSC	1024TOSC	—
EC, RC	Greater of: 96 ms or 1024TOSC	—	—

The time-out sequence begins from the first rising edge of $\overline{MCLR}$.

Table 4-3 shows the reset conditions for some special registers, while Table 4-4 shows the initialization conditions for all the registers. The shaded registers (in Table 4-4) are for all devices except the PIC17C42. In the PIC17C42, the PRODH and PRODL registers are general purpose RAM.

TABLE 4-2: STATUS BITS AND THEIR SIGNIFICANCE

$\overline{TO}$	$\overline{PD}$	Event
1	1	Power-on Reset, $\overline{MCLR}$ Reset during normal operation, or CLRWDT instruction executed
1	0	$\overline{MCLR}$ Reset during SLEEP or interrupt wake-up from SLEEP
0	1	WDT Reset during normal operation
0	0	WDT Reset during SLEEP

In Figure 4-2, Figure 4-3 and Figure 4-4, TPWRT > TOST, as would be the case in higher frequency crystals. For lower frequency crystals, (i.e., 32 kHz) TOST would be greater.

TABLE 4-3: RESET CONDITION FOR THE PROGRAM COUNTER AND THE CPUSTA REGISTER

Event		PCH:PCL	CPUSTA	OST Active
Power-on Reset		0000h	--11 11--	Yes
$\overline{MCLR}$ Reset during normal operation		0000h	--11 11--	No
$\overline{MCLR}$ Reset during SLEEP		0000h	--11 10--	Yes (2)
WDT Reset during normal operation		0000h	--11 01--	No
WDT Reset during SLEEP (3)		0000h	--11 00--	Yes (2)
Interrupt wake-up from SLEEP	GLINTD is set	PC + 1	--11 10--	Yes (2)
	GLINTD is clear	PC + 1 (1)	--10 10--	Yes (2)

Legend: u = unchanged, x = unknown, - = unimplemented read as '0'.

Note 1: On wake-up, this instruction is executed. The instruction at the appropriate interrupt vector is fetched and then executed.

2: The OST is only active when the Oscillator is configured for XT or LF modes.

3: The Program Counter = 0, that is the device branches to the reset vector. This is different from the mid-range devices.

5.4 Interrupt Operation

Global Interrupt Disable bit, GLINTD (CPUSTA<4>), enables all unmasked interrupts (if clear) or disables all interrupts (if set). Individual interrupts can be disabled through their corresponding enable bits in the INTSTA register. Peripheral interrupts need either the global peripheral enable PEIE bit disabled, or the specific peripheral enable bit disabled. Disabling the peripherals via the global peripheral enable bit, disables all peripheral interrupts. GLINTD is set on reset (interrupts disabled).

The RETFIE instruction allows returning from interrupt and re-enable interrupts at the same time.

When an interrupt is responded to, the GLINTD bit is automatically set to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with interrupt vector. There are four interrupt vectors to reduce interrupt latency.

The peripheral interrupt vector has multiple interrupt sources. Once in the peripheral interrupt service routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The peripheral interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid continuous interrupts.

The PIC17C4X devices have four interrupt vectors. These vectors and their hardware priority are shown in Table 5-1. If two enabled interrupts occur “at the same time”, the interrupt of the highest priority will be serviced first. This means that the vector address of that interrupt will be loaded into the program counter (PC).

TABLE 5-1: INTERRUPT VECTORS/ PRIORITIES

Address	Vector	Priority
0008h	External Interrupt on RA0/ INT pin (INTF)	1 (Highest)
0010h	TMR0 overflow interrupt (T0IF)	2
0018h	External Interrupt on T0CKI (T0CKIF)	3
0020h	Peripherals (PEIF)	4 (Lowest)

Note 1: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GLINTD bit.

Note 2: When disabling any of the INTSTA enable bits, the GLINTD bit should be set (disabled).

Note 3: For the PIC17C42 only:
If an interrupt occurs while the Global Interrupt Disable (GLINTD) bit is being set, the GLINTD bit may unintentionally be re-enabled by the user’s Interrupt Service Routine (the RETFIE instruction). The events that would cause this to occur are:

1. An interrupt occurs simultaneously with an instruction that sets the GLINTD bit.
2. The program branches to the Interrupt vector and executes the Interrupt Service Routine.
3. The Interrupt Service Routine completes with the execution of the RETFIE instruction. This causes the GLINTD bit to be cleared (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.

The method to ensure that interrupts are globally disabled is:

1. Ensure that the GLINTD bit was set by the instruction, as shown in the following code:

```
LOOP   BSF    CPUSTA, GLINTD ; Disable Global
                              ; Interrupt
       BTFSS  CPUSTA, GLINTD ; Global Interrupt
                              ; Disabled?
       GOTO   LOOP           ; NO, try again
                              ; YES, continue
                              ; with program
                              ; low
```

6.8 Bank Select Register (BSR)

The BSR is used to switch between banks in the data memory area (Figure 6-13). In the PIC17C42, PIC17CR42, and PIC17C42A only the lower nibble is implemented. While in the PIC17C43, PIC17CR43, and PIC17C44 devices, the entire byte is implemented. The lower nibble is used to select the peripheral register bank. The upper nibble is used to select the general purpose memory bank.

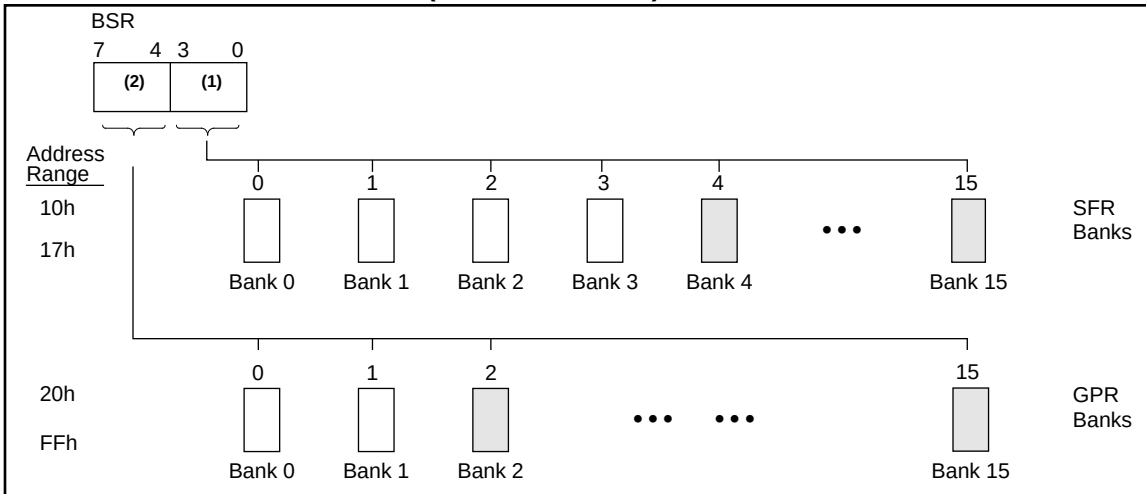
All the Special Function Registers (SFRs) are mapped into the data memory space. In order to accommodate the large number of registers, a banking scheme has been used. A segment of the SFRs, from address 10h to address 17h, is banked. The lower nibble of the bank select register (BSR) selects the currently active "peripheral bank." Effort has been made to group the peripheral registers of related functionality in one bank. However, it will still be necessary to switch from bank to bank in order to address all peripherals related to a single task. To assist this, a `MOVLB bank` instruction is in the instruction set.

For the PIC17C43, PIC17CR43, and PIC17C44 devices, the need for a large general purpose memory space dictated a general purpose RAM banking scheme. The upper nibble of the BSR selects the currently active general purpose RAM bank. To assist this, a `MOVLR bank` instruction has been provided in the instruction set.

If the currently selected bank is not implemented (such as Bank 13), any read will read all '0's. Any write is completed to the bit bucket and the ALU status bits will be set/cleared as appropriate.

Note:	Registers in Bank 15 in the Special Function Register area, are reserved for Microchip use. Reading of registers in this bank may cause random values to be read.

FIGURE 6-13: BSR OPERATION (PIC17C43/R43/44)



Note 1: Only Banks 0 through Bank 3 are implemented. Selection of an unimplemented bank is not recommended**.**
Bank 15 is reserved for Microchip use, reading of registers in this bank may cause random values to be read.
2: Only Banks 0 and Bank 1 are implemented. Selection of an unimplemented bank is not recommended.

9.2 PORTB and DDRB Registers

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is DDRB. A '1' in DDRB configures the corresponding port pin as an input. A '0' in the DDRB register configures the corresponding port pin as an output. Reading PORTB reads the status of the pins, whereas writing to it will write to the port latch.

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is done by clearing the $\overline{\text{RBPU}}$ (PORTA<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are enabled on any reset.

PORTB also has an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e. any RB7:RB0 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB0) are compared with the value in the PORTB data latch. The "mismatch" outputs of RB7:RB0 are OR'ed together to generate the PORTB Interrupt Flag RBIF (PIR<7>).

This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt by:

a) Read-Write PORTB (such as; `MOVPF PORTB, PORTB`). This will end mismatch condition.

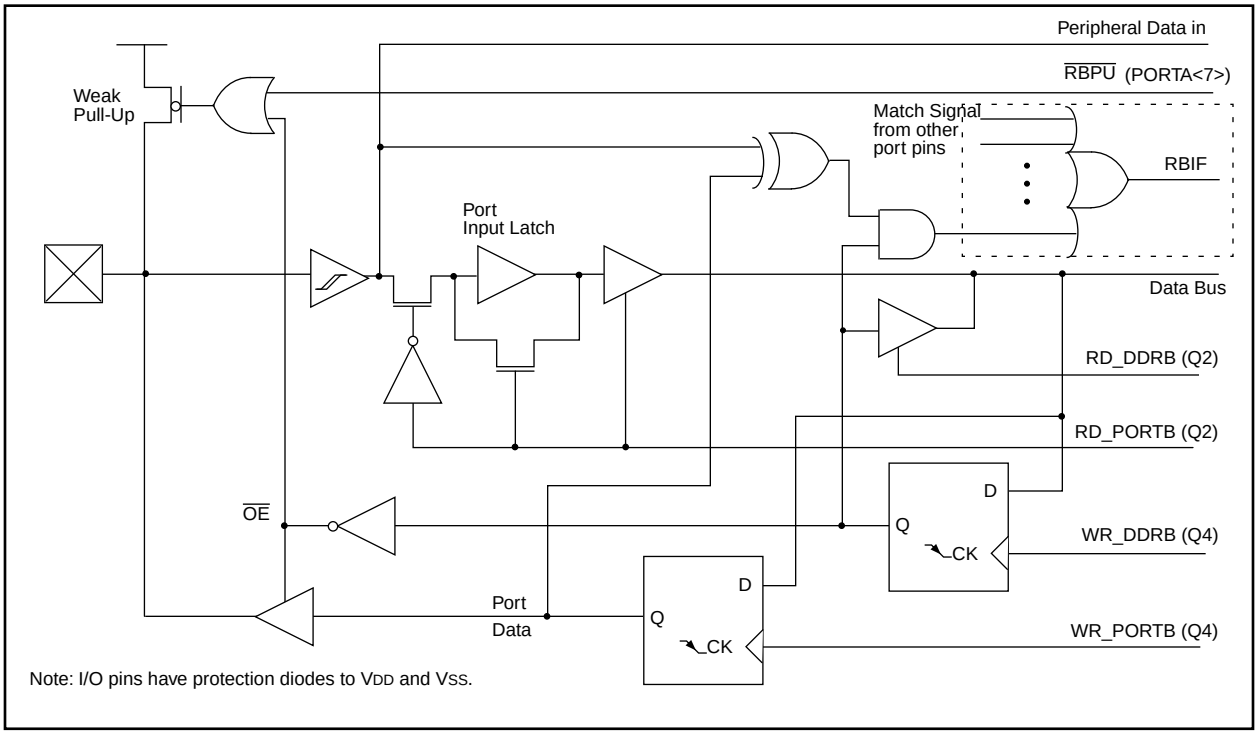
b) Then, clear the RBIF bit.

A mismatch condition will continue to set the RBIF bit. Reading then writing PORTB will end the mismatch condition, and allow the RBIF bit to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on this port, allows easy interface to a key pad and make it possible for wake-up on key-depression. For an example, refer to AN552 in the *Embedded Control Handbook*.

The interrupt on change feature is recommended for wake-up on operations where PORTB is only used for the interrupt on change feature and key depression operation.

FIGURE 9-4: BLOCK DIAGRAM OF RB<7:4> AND RB<1:0> PORT PINS



9.4.1 PORTE AND DDRE REGISTER

PORTE is a 3-bit bi-directional port. The corresponding data direction register is DDRE. A '1' in DDRE configures the corresponding port pin as an input. A '0' in the DDRE register configures the corresponding port pin as an output. Reading PORTE reads the status of the pins, whereas writing to it will write to the port latch. PORTE is multiplexed with the system bus. When operating as the system bus, PORTE contains the control signals for the address/data bus (AD15:AD0). These control signals are Address Latch Enable (ALE), Output Enable ($\overline{OE}$), and Write ($\overline{WR}$). The control signals $\overline{OE}$ and $\overline{WR}$ are active low signals. The timing for the system bus is shown in the Electrical Characteristics section.

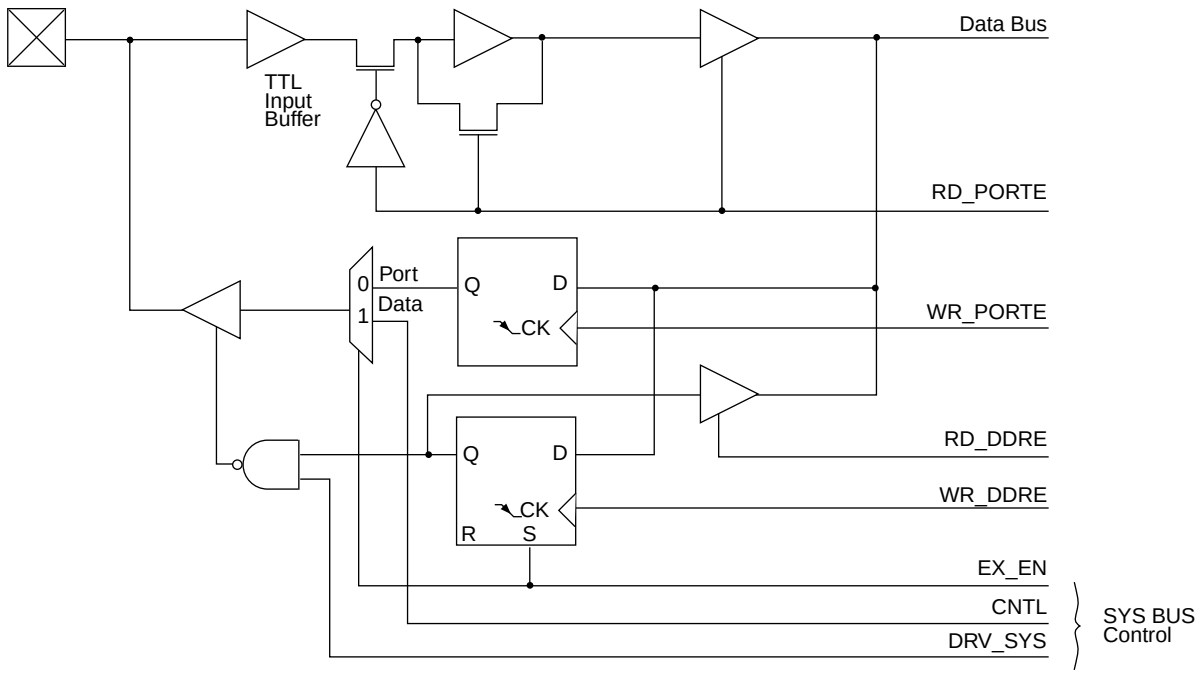
Note:	This port is configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, this port is a general purpose I/O.

Example 9-4 shows the instruction sequence to initialize PORTE. The Bank Select Register (BSR) must be selected to Bank 1 for the port to be initialized.

EXAMPLE 9-4: INITIALIZING PORTE

```
MOVLB  1          ;  Select Bank 1
CLRF   PORTE      ;  Initialize PORTE data
                  ;   latches before setting
                  ;   the data direction
                  ;   register
MOVLW  0x03       ;  Value used to initialize
                  ;   data direction
MOVWF  DDRE       ;  Set RE<1:0> as inputs
                  ;   RE<2> as outputs
                  ;   RE<7:3> are always
                  ;   read as '0'
```

FIGURE 9-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)



Note: I/O pins have protection diodes to VDD and Vss.

12.2.2 DUAL CAPTURE REGISTER MODE

This mode is selected by setting CA1/$\overline{PR3}$. A block diagram is shown in Figure 12-8. In this mode, TMR3 runs without a period register and increments from 0000h to FFFFh and rolls over to 0000h. The TMR3 interrupt Flag (TMR3IF) is set on this roll over. The TMR3IF bit must be cleared in software.

Registers PR3H/CA1H and PR3L/CA1L make a 16-bit capture register (Capture1). It captures events on pin RB0/CAP1. Capture mode is configured by the CA1ED1 and CA1ED0 bits. Capture1 Interrupt Flag bit (CA1IF) is set on the capture event. The corresponding interrupt mask bit is CA1IE. The Capture1 Overflow Status bit is CA1OVF.

The Capture2 overflow status flag bit is double buffered. The master bit is set if one captured word is already residing in the Capture2 register and another "event" has occurred on the RB1/CA2 pin. The new event will not transfer the TMR3 value to the capture register which protects the previous unread capture value. When the user reads both the high and the low bytes (in any order) of the Capture2 register, the master overflow bit is transferred to the slave overflow bit (CA2OVF) and then the master bit is reset. The user can then read TCON2 to determine the value of CA2OVF.

The operation of the Capture1 feature is identical to Capture2 (as described in Section 12.2.1).

FIGURE 12-8: TIMER3 WITH TWO CAPTURE REGISTERS BLOCK DIAGRAM

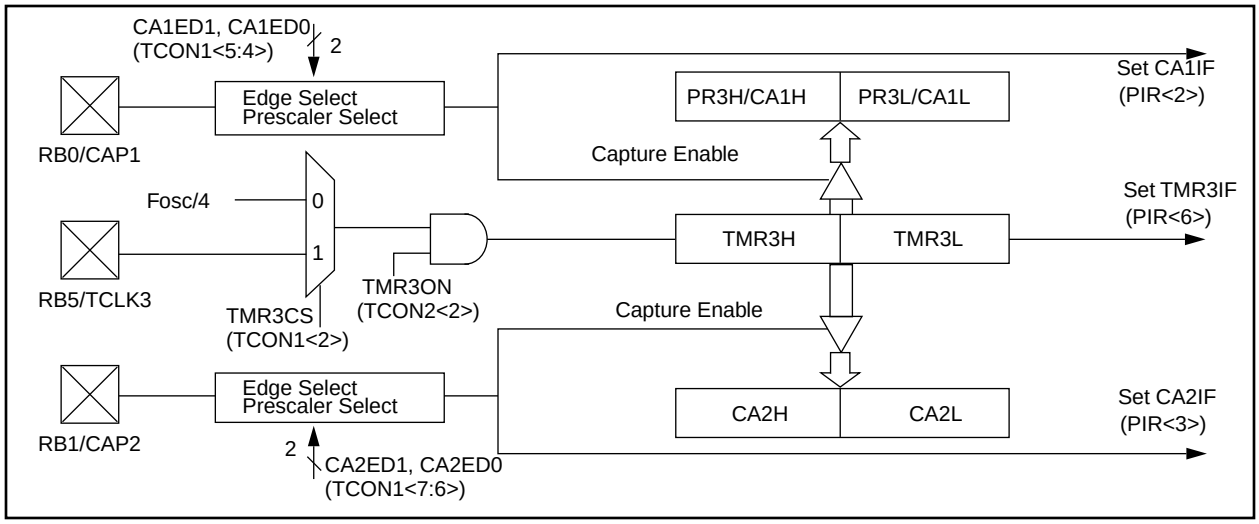


TABLE 12-5: REGISTERS ASSOCIATED WITH CAPTURE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 3	TCON1	CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS	0000 0000	0000 0000
17h, Bank 3	TCON2	CA2OVF	CA1OVF	PWM2ON	PWM1ON	CA1/$\overline{PR3}$	TMR3ON	TMR2ON	TMR1ON	0000 0000	0000 0000
12h, Bank 2	TMR3L	TMR3 register; low byte								xxxx xxxx	uuuu uuuu
13h, Bank 2	TMR3H	TMR3 register; high byte								xxxx xxxx	uuuu uuuu
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
07h, Unbanked	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
06h, Unbanked	CPUSTA	—	—	STKAV	GLINTD	$\overline{TO}$	$\overline{PD}$	—	—	--11 11--	--11 qq--
16h, Bank 2	PR3L/CA1L	Timer3 period register, low byte/capture1 register, low byte								xxxx xxxx	uuuu uuuu
17h, Bank 2	PR3H/CA1H	Timer3 period register, high byte/capture1 register, high byte								xxxx xxxx	uuuu uuuu
14h, Bank 3	CA2L	Capture2 low byte								xxxx xxxx	uuuu uuuu
15h, Bank 3	CA2H	Capture2 high byte								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as '0', q - value depends on condition, shaded cells are not used by Capture.

Note 1: Other (non power-up) resets include: external reset through $\overline{MCLR}$ and WDT Timer Reset.

TABLE 13-4: BAUD RATES FOR ASYNCHRONOUS MODE

BAUD RATE (K)	FOSC = 33 MHz			FOSC = 25 MHz			FOSC = 20 MHz			FOSC = 16 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	1.221	+1.73	255	1.202	+0.16	207
2.4	2.398	-0.07	214	2.396	0.14	162	2.404	+0.16	129	2.404	+0.16	103
9.6	9.548	-0.54	53	9.53	-0.76	40	9.469	-1.36	32	9.615	+0.16	25
19.2	19.09	-0.54	26	19.53	+1.73	19	19.53	+1.73	15	19.23	+0.16	12
76.8	73.66	-4.09	6	78.13	+1.73	4	78.13	+1.73	3	83.33	+8.51	2
96	103.12	+7.42	4	97.65	+1.73	3	104.2	+8.51	2	NA	—	—
300	257.81	-14.06	1	390.63	+30.21	0	312.5	+4.17	0	NA	—	—
500	515.62	+3.13	0	NA	—	—	NA	—	—	NA	—	—
HIGH	515.62	—	0	—	—	0	312.5	—	0	250	—	0
LOW	2.014	—	255	1.53	—	255	1.221	—	255	0.977	—	255

BAUD RATE (K)	FOSC = 10 MHz			FOSC = 7.159 MHz			FOSC = 5.068 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	0.31	+3.13	255
1.2	1.202	+0.16	129	1.203	_0.23	92	1.2	0	65
2.4	2.404	+0.16	64	2.380	-0.83	46	2.4	0	32
9.6	9.766	+1.73	15	9.322	-2.90	11	9.9	-3.13	7
19.2	19.53	+1.73	7	18.64	-2.90	5	19.8	+3.13	3
76.8	78.13	+1.73	1	NA	—	—	79.2	+3.13	0
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	156.3	—	0	111.9	—	0	79.2	—	0
LOW	0.610	—	255	0.437	—	255	0.309	—	255

BAUD RATE (K)	FOSC = 3.579 MHz			FOSC = 1 MHz			FOSC = 32.768 kHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	0.301	+0.23	185	0.300	+0.16	51	0.256	-14.67	1
1.2	1.190	-0.83	46	1.202	+0.16	12	NA	—	—
2.4	2.432	+1.32	22	2.232	-6.99	6	NA	—	—
9.6	9.322	-2.90	5	NA	—	—	NA	—	—
19.2	18.64	-2.90	2	NA	—	—	NA	—	—
76.8	NA	—	—	NA	—	—	NA	—	—
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	55.93	—	0	15.63	—	0	0.512	—	0
LOW	0.218	—	255	0.061	—	255	0.002	—	255

13.4 USART Synchronous Slave Mode

The synchronous slave mode differs from the master mode in the fact that the shift clock is supplied externally at the RA5/TX/CK pin (instead of being supplied internally in the master mode). This allows the device to transfer or receive data in the SLEEP mode. The slave mode is entered by clearing the CSRC (TXSTA<7>) bit.

13.4.1 USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the sync master and slave modes are identical except in the case of the SLEEP mode.

If two words are written to TXREG and then the SLEEP instruction executes, the following will occur. The first word will immediately transfer to the TSR and will transmit as the shift clock is supplied. The second word will remain in TXREG. TXIF will not be set. When the first word has been shifted out of TSR, TXREG will transfer the second word to the TSR and the TXIF flag will now be set. If TXIE is enabled, the interrupt will wake the chip from SLEEP and if the global interrupt is enabled, then the program will branch to interrupt vector (0020h).

Steps to follow when setting up a Synchronous Slave Transmission:

1. Enable the synchronous slave serial port by setting the SYNC and SPEN bits and clearing the CSRC bit.
2. Clear the CREN bit.
3. If interrupts are desired, then set the TXIE bit.
4. If 9-bit transmission is desired, then set the TX9 bit.
5. Start transmission by loading data to TXREG.
6. If 9-bit transmission is selected, the ninth bit should be loaded in TX9D.
7. Enable the transmission by setting TXEN.

Writing the transmit data to the TXREG, then enabling the transmit (setting TXEN) allows transmission to start sooner then doing these two events in the reverse order.

Note:	To terminate a transmission, either clear the SPEN bit, or the TXEN bit. This will reset the transmit logic, so that it will be in the proper state when transmit is re-enabled.

13.4.2 USART SYNCHRONOUS SLAVE RECEPTION

Operation of the synchronous master and slave modes are identical except in the case of the SLEEP mode. Also, SREN is a don't care in slave mode.

If receive is enabled (CREN) prior to the SLEEP instruction, then a word may be received during SLEEP. On completely receiving the word, the RSR will transfer the data to RCREG (setting RCIF) and if the RCIE bit is set, the interrupt generated will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector (0020h).

Steps to follow when setting up a Synchronous Slave Reception:

1. Enable the synchronous master serial port by setting the SYNC and SPEN bits and clearing the CSRC bit.
2. If interrupts are desired, then set the RCIE bit.
3. If 9-bit reception is desired, then set the RX9 bit.
4. To enable reception, set the CREN bit.
5. The RCIF bit will be set when reception is complete and an interrupt will be generated if the RCIE bit was set.
6. Read RCSTA to get the ninth bit (if enabled) and determine if any error occurred during reception.
7. Read the 8-bit received data by reading RCREG.
8. If any error occurred, clear the error by clearing the CREN bit.

Note:	To abort reception, either clear the SPEN bit, the SREN bit (when in single receive mode), or the CREN bit (when in continuous receive mode). This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

TABLE 15-2: PIC17CXX INSTRUCTION SET (Cont.'d)

Mnemonic, Operands		Description	Cycles	16-bit Opcode				Status Affected	Notes
				MSb			LSb		
TABLWT	**t,i,f**	Table Write	2	1010	11ti	ffff	ffff	None	5
TLRD	**t,f**	Table Latch Read	1	1010	00tx	ffff	ffff	None	
TLWT	**t,f**	Table Latch Write	1	1010	01tx	ffff	ffff	None	
TSTFSZ	**f**	Test f, skip if 0	1 (2)	0011	0011	ffff	ffff	None	6,8
XORWF	**f,d**	Exclusive OR WREG with f	1	0000	110d	ffff	ffff	Z	
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	**f,b**	Bit Clear f	1	1000	1bbb	ffff	ffff	None	
BSF	**f,b**	Bit Set f	1	1000	0bbb	ffff	ffff	None	
BTFSC	**f,b**	Bit test, skip if clear	1 (2)	1001	1bbb	ffff	ffff	None	6,8
BTFSS	**f,b**	Bit test, skip if set	1 (2)	1001	0bbb	ffff	ffff	None	6,8
BTG	**f,b**	Bit Toggle f	1	0011	1bbb	ffff	ffff	None	
LITERAL AND CONTROL OPERATIONS									
ADDLW	**k**	ADD literal to WREG	1	1011	0001	kkkk	kkkk	OV,C,DC,Z	
ANDLW	**k**	AND literal with WREG	1	1011	0101	kkkk	kkkk	Z	
CALL	**k**	Subroutine Call	2	111k	kkkk	kkkk	kkkk	None	7
CLRWDT	**—**	Clear Watchdog Timer	1	0000	0000	0000	0100	$\overline{TO}$,$\overline{PD}$	
GOTO	**k**	Unconditional Branch	2	110k	kkkk	kkkk	kkkk	None	7
IORLW	**k**	Inclusive OR literal with WREG	1	1011	0011	kkkk	kkkk	Z	
LCALL	**k**	Long Call	2	1011	0111	kkkk	kkkk	None	4,7
MOVLB	**k**	Move literal to low nibble in BSR	1	1011	1000	uuuu	kkkk	None	
MOVLR	**k**	Move literal to high nibble in BSR	1	1011	101x	kkkk	uuuu	None	9
MOVLW	**k**	Move literal to WREG	1	1011	0000	kkkk	kkkk	None	
MULLW	**k**	Multiply literal with WREG	1	1011	1100	kkkk	kkkk	None	9
RETFIE	**—**	Return from interrupt (and enable interrupts)	2	0000	0000	0000	0101	GLINTD	7
RETLW	**k**	Return literal to WREG	2	1011	0110	kkkk	kkkk	None	7
RETURN	**—**	Return from subroutine	2	0000	0000	0000	0010	None	7
SLEEP	**—**	Enter SLEEP Mode	1	0000	0000	0000	0011	$\overline{TO}$, $\overline{PD}$	
SUBLW	**k**	Subtract WREG from literal	1	1011	0010	kkkk	kkkk	OV,C,DC,Z	
XORLW	**k**	Exclusive OR literal with WREG	1	1011	0100	kkkk	kkkk	Z	

Legend: Refer to Table 15-1 for opcode field descriptions.

Note 1: 2's Complement method.

2: Unsigned arithmetic.

3: If s = '1', only the file is affected: If s = '0', both the WREG register and the file are affected; If only the Working register (WREG) is required to be affected, then f = WREG must be specified.

4: During an LCALL, the contents of PCLATH are loaded into the MSB of the PC and kkkk kkkk is loaded into the LSB of the PC (PCL)

5: Multiple cycle instruction for EPROM programming when table pointer selects internal EPROM. The instruction is terminated by an interrupt event. When writing to external program memory, it is a two-cycle instruction.

6: Two-cycle instruction when condition is true, else single cycle instruction.

7: Two-cycle instruction except for TABLRD to PCL (program counter low byte) in which case it takes 3 cycles.

8: A "skip" means that instruction fetched during execution of current instruction is not executed, instead an NOP is executed.

9: These instructions are not available on the PIC17C42.

MOVFP **Move f to p**

Syntax: [*label*] MOVFP f,p

Operands: $0 \le f \le 255$
$0 \le p \le 31$

Operation: (f) → (p)

Status Affected: None

Encoding:

011p	pppp	ffff	ffff

Description: Move data from data memory location 'f' to data memory location 'p'. Location 'f' can be anywhere in the 256 word data space (00h to FFh) while 'p' can be 00h to 1Fh.

Either 'p' or 'f' can be WREG (a useful special situation).

MOVFP is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port). Both 'f' and 'p' can be indirectly addressed.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'p'

Example: MOVFP REG1, REG2

Before Instruction
REG1 = 0x33,
REG2 = 0x11

After Instruction
REG1 = 0x33,
REG2 = 0x33

MOVLB **Move Literal to low nibble in BSR**

Syntax: [*label*] MOVLB k

Operands: $0 \le k \le 15$

Operation: k → (BSR<3:0>)

Status Affected: None

Encoding:

1011	1000	uuuu	kkkk

Description: The four bit literal 'k' is loaded in the Bank Select Register (BSR). Only the low 4-bits of the Bank Select Register are affected. The upper half of the BSR is unchanged. The assembler will encode the “u” fields as '0'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'u:k'	Execute	Write literal 'k' to BSR<3:0>

Example: MOVLB 0x5

Before Instruction
BSR register = 0x22

After Instruction
BSR register = 0x25

Note: For the PIC17C42, only the low four bits of the BSR register are physically implemented. The upper nibble is read as '0'.

NEGW **Negate W**

Syntax: [*label*] NEGW f,s

Operands: $0 \le F \le 255$
$s \in [0,1]$

Operation: $\overline{WREG} + 1 \rightarrow (f)$;
$\overline{WREG} + 1 \rightarrow s$

Status Affected: OV, C, DC, Z

Encoding:

0010	110s	ffff	ffff

Description: WREG is negated using two's complement. If 's' is 0 the result is placed in WREG and data memory location 'f'. If 's' is 1 the result is placed only in data memory location 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f' and other specified register

Example: `NEGW REG,0`

Before Instruction
WREG = 0011 1010 [0x3A],
REG = 1010 1011 [0xAB]

After Instruction
WREG = 1100 0111 [0xC6]
REG = 1100 0111 [0xC6]

NOP **No Operation**

Syntax: [*label*] NOP

Operands: None

Operation: No operation

Status Affected: None

Encoding:

0000	0000	0000	0000

Description: No operation.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	NOP	Execute	NOP

Example:

None.

RRNCF **Rotate Right f (no carry)**

Syntax: [*label*] RRNCF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

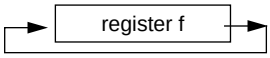
Operation: f<n> → d<n-1>;
f<0> → d<7>

Status Affected: None

Encoding:

0010	000d	ffff	ffff

Description: The contents of register 'f' are rotated one bit to the right. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.



Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example 1:
```
RRNCF   REG, 1
```
Before Instruction
```
WREG  =  ?
REG   =  1101 0111
```
After Instruction
```
WREG  =  0
REG   =  1110 1011
```

Example 2:
```
RRNCF   REG, 0
```
Before Instruction
```
WREG  =  ?
REG   =  1101 0111
```
After Instruction
```
WREG  =  1110 1011
REG   =  1101 0111
```

SETF **Set f**

Syntax: [*label*] SETF f,s

Operands: $0 \le f \le 255$
$s \in [0,1]$

Operation: FFh → f;
FFh → d

Status Affected: None

Encoding:

0010	101s	ffff	ffff

Description: If 's' is 0, both the data memory location 'f' and WREG are set to FFh. If 's' is 1 only the data memory location 'f' is set to FFh.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f' and other specified register

Example1:
```
SETF    REG, 0
```
Before Instruction
```
REG   =  0xDA
WREG  =  0x05
```
After Instruction
```
REG   =  0xFF
WREG  =  0xFF
```
Example2:
```
SETF    REG, 1
```
Before Instruction
```
REG   =  0xDA
WREG  =  0x05
```
After Instruction
```
REG   =  0xFF
WREG  =  0x05
```

TLWT **Table Latch Write**

Syntax: [*label*] TLWT t,f

Operands: $0 \le f \le 255$
$t \in [0,1]$

Operation: If t = 0,
$f \rightarrow$ TBLATL;
If t = 1,
$f \rightarrow$ TBLATH

Status Affected: None

Encoding:

1010	01tx	ffff	ffff

Description: Data from file register 'f' is written into the 16-bit table latch (TBLAT).
If t = 1; high byte is written
If t = 0; low byte is written
This instruction is used in conjunction with TABLWT to transfer data from data memory to program memory.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register TBLATH or TBLATL

Example:
```
TLWT    t, RAM
```
Before Instruction
t = 0
RAM = 0xB7
TBLAT = 0x0000 (TBLATH = 0x00)
(TBLATL = 0x00)

After Instruction
RAM = 0xB7
TBLAT = 0x00B7 (TBLATH = 0x00)
(TBLATL = 0xB7)

Before Instruction
t = 1
RAM = 0xB7
TBLAT = 0x0000 (TBLATH = 0x00)
(TBLATL = 0x00)

After Instruction
RAM = 0xB7
TBLAT = 0xB700 (TBLATH = 0xB7)
(TBLATL = 0x00)

TSTFSZ **Test f, skip if 0**

Syntax: [*label*] TSTFSZ f

Operands: $0 \le f \le 255$

Operation: skip if f = 0

Status Affected: None

Encoding:

0011	0011	ffff	ffff

Description: If 'f' = 0, the next instruction, fetched during the current instruction execution, is discarded and an NOP is executed making this a two-cycle instruction.

Words: 1

Cycles: 1 (2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	NOP

If skip:

Q1	Q2	Q3	Q4
Forced NOP	NOP	Execute	NOP

Example:
```
HERE    TSTFSZ  CNT
NZERO   :
ZERO    :
```
Before Instruction
PC = Address(HERE)

After Instruction
If CNT = 0x00,
PC = Address (ZERO)
If CNT ≠ 0x00,
PC = Address (NZERO)

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 17-5: TIMER0 CLOCK TIMINGS

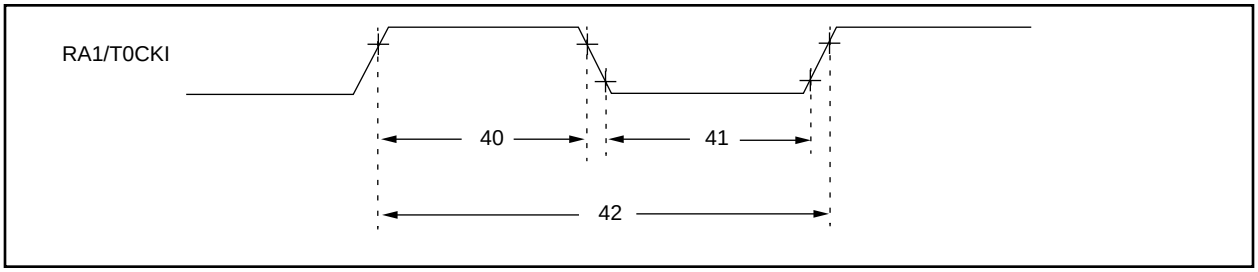


TABLE 17-5: TIMER0 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5TCY + 20 §	—	—	ns	
			With Prescaler	10*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5TCY + 20 §	—	—	ns	
			With Prescaler	10*	—	—	ns	
42	Tt0P	T0CKI Period		TCY + 40 § / N	—	—	ns	N = prescale value (1, 2, 4, ..., 256)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25˚C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 17-6: TIMER1, TIMER2, AND TIMER3 CLOCK TIMINGS

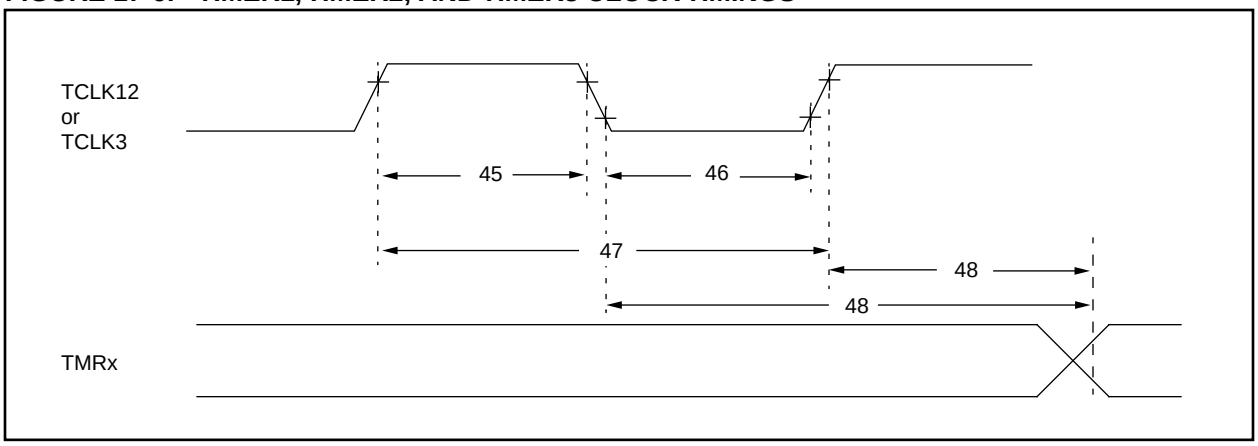


TABLE 17-6: TIMER1, TIMER2, AND TIMER3 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ †	Max	Units	Conditions
45	Tt123H	TCLK12 and TCLK3 high time	0.5 TCY + 20 §	—	—	ns	
46	Tt123L	TCLK12 and TCLK3 low time	0.5 TCY + 20 §	—	—	ns	
47	Tt123P	TCLK12 and TCLK3 input period	TCY + 40 § / N	—	—	ns	N = prescale value (1, 2, 4, 8)
48	TckE2tmrI	Delay from selected External Clock Edge to Timer increment	2TOSC §	—	6 Tosc §	—	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25˚C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Applicable Devices	42	R42	42A	43	R43	44

18.0 PIC17C42 DC AND AC CHARACTERISTICS

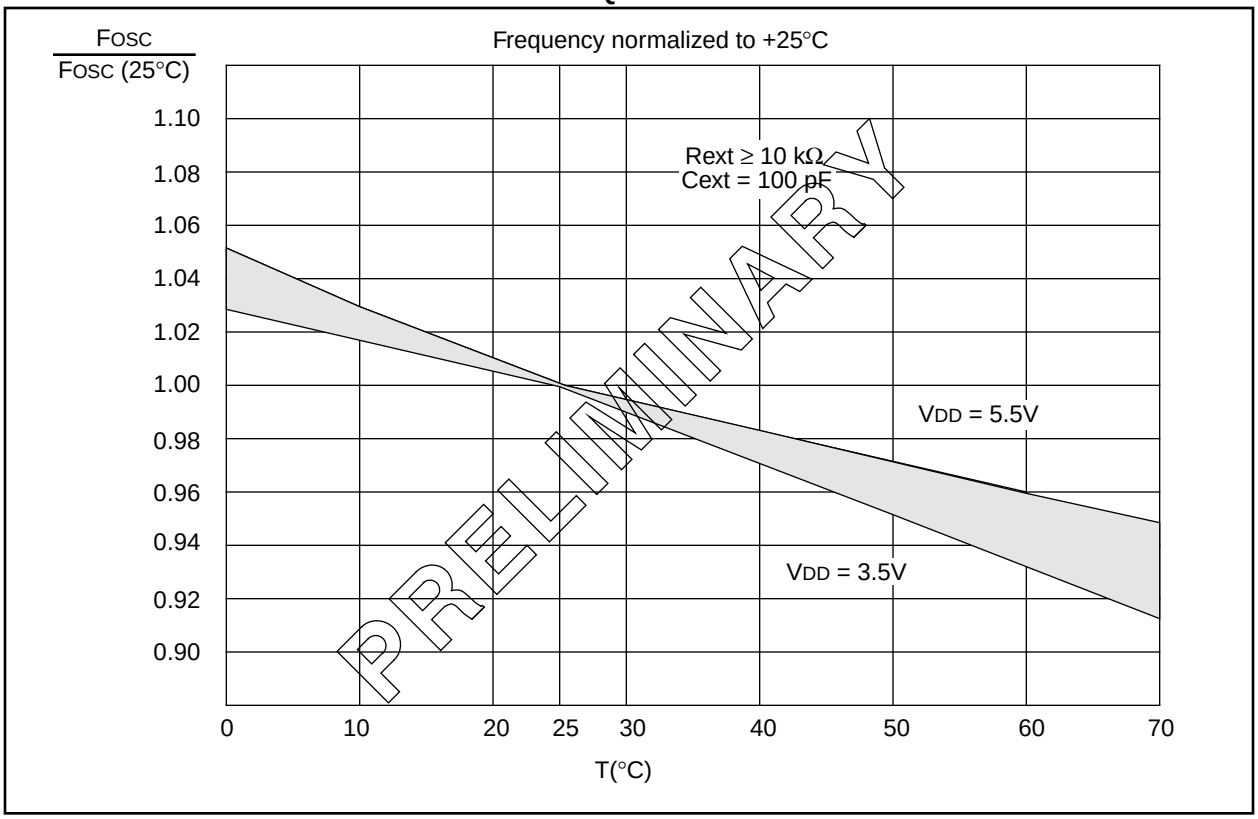
The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g. outside specified VDD range). This is for information only and devices are ensured to operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3σ) and (mean - 3σ) respectively where σ is standard deviation.

TABLE 18-1: PIN CAPACITANCE PER PACKAGE TYPE

Pin Name	Typical Capacitance (pF)			
	40-pin DIP	44-pin PLCC	44-pin MQFP	44-pin TQFP
All pins, except $\overline{MCLR}$, VDD, and VSS	10	10	10	10
$\overline{MCLR}$ pin	20	20	20	20

FIGURE 18-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE



Applicable Devices	42	R42	42A	43	R43	44

FIGURE 18-17: IOL vs. VOL, VDD = 5V

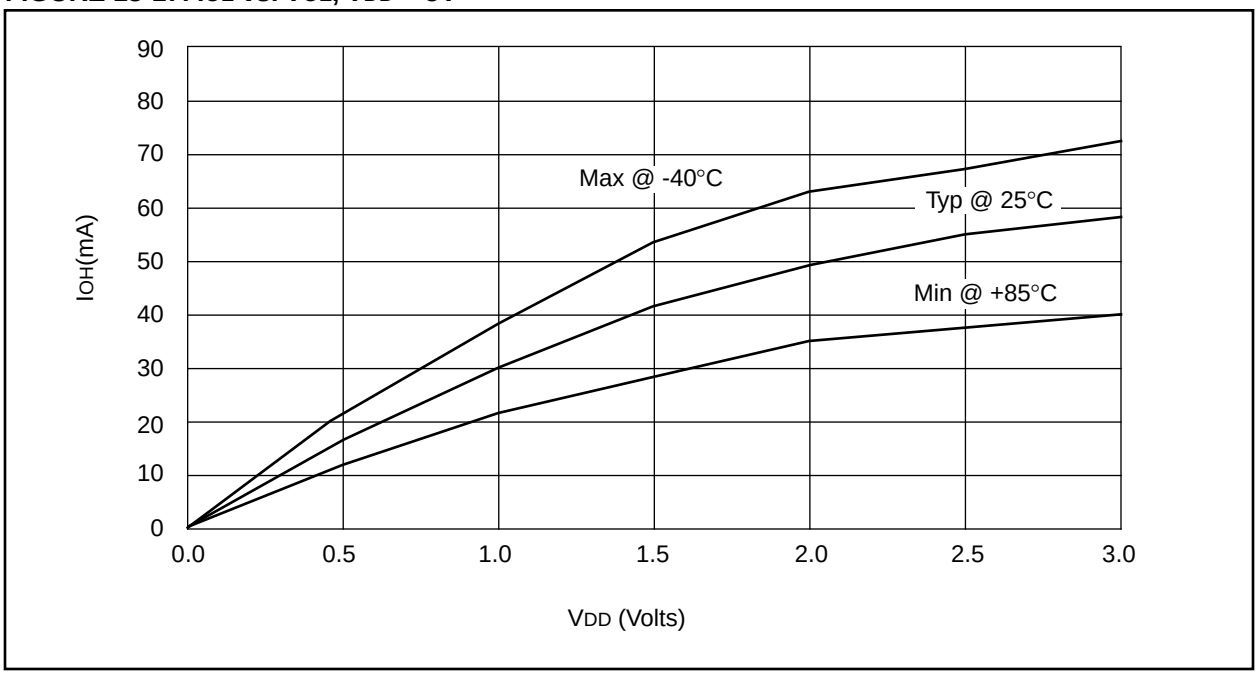
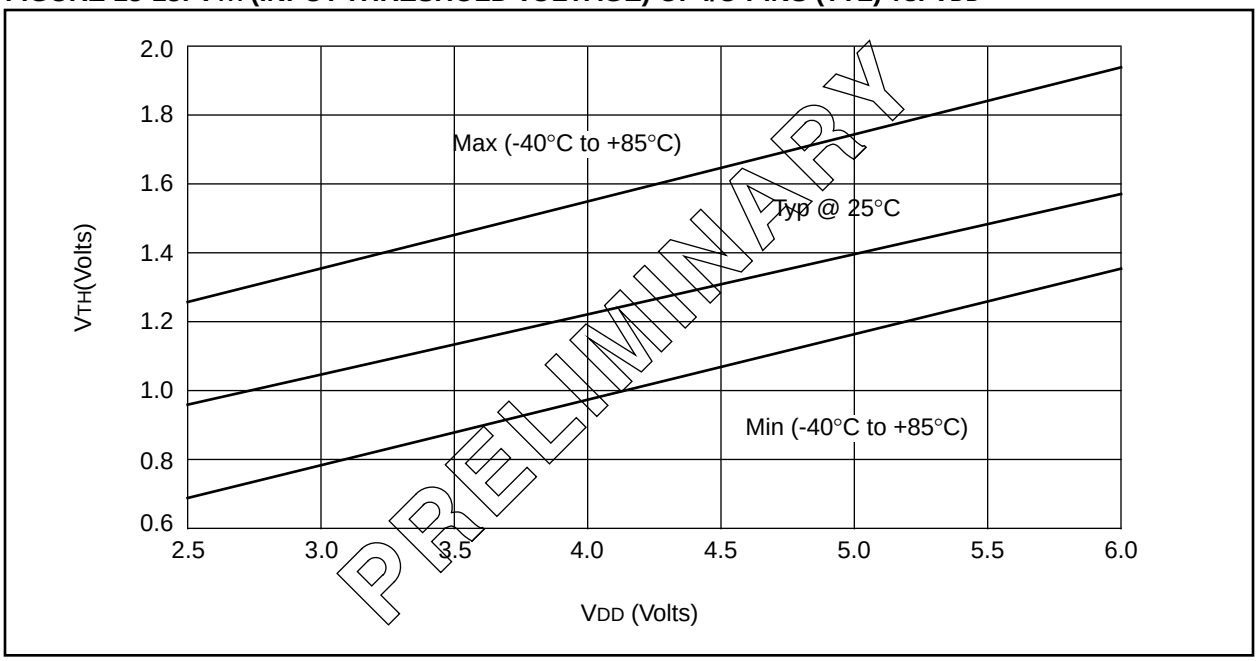


FIGURE 18-18: VTH (INPUT THRESHOLD VOLTAGE) OF I/O PINS (TTL) vs. VDD



Applicable Devices	42	R42	42A	43	R43	44

FIGURE 20-5: TRANSCONDUCTANCE (gm) OF LF OSCILLATOR vs. VDD

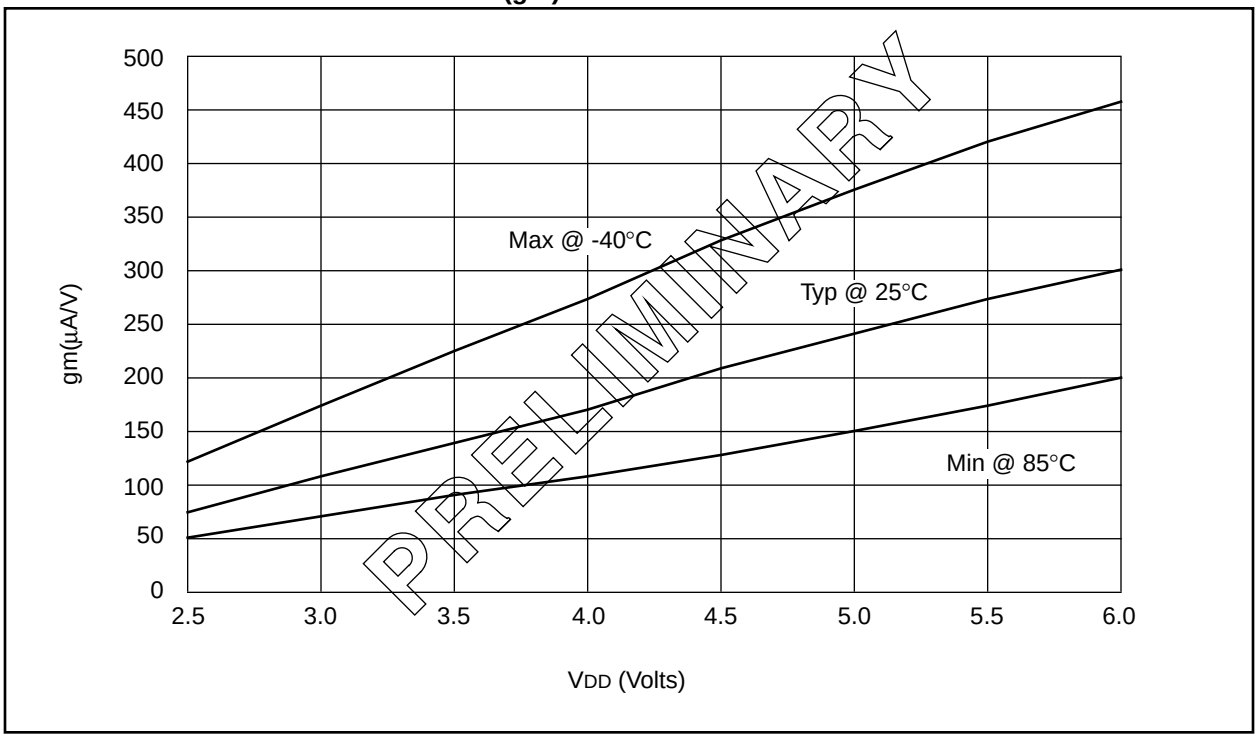
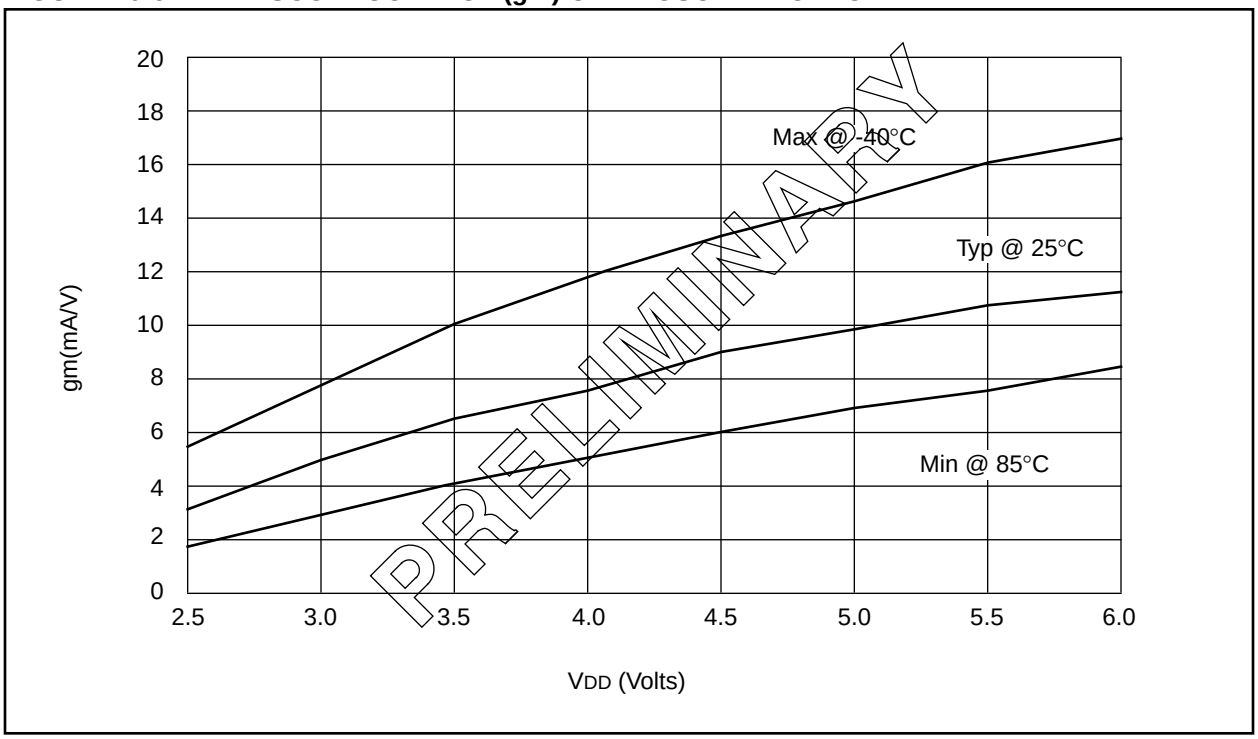


FIGURE 20-6: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD



E.2 PIC16C5X Family of Devices

	Clock	Memory				Peripherals		Features	
	Maximum Frequency of Operation (MHz)	Program Memory (x12 words)	EPROM	ROM	RAM Data Memory (bytes)	Timer Module(s)	I/O Pins	Voltage Range (Volts)	Number of Instructions	Packages
PIC16C52	4	384	—	25	TMR0	12	2.5-6.25	33	18-pin DIP, SOIC
PIC16C54	20	512	—	25	TMR0	12	2.5-6.25	33	18-pin DIP, SOIC; 20-pin SSOP
PIC16C54A	20	512	—	25	TMR0	12	2.0-6.25	33	18-pin DIP, SOIC; 20-pin SSOP
PIC16CR54A	20	—	512	25	TMR0	12	2.0-6.25	33	18-pin DIP, SOIC; 20-pin SSOP
PIC16C55	20	512	—	24	TMR0	20	2.5-6.25	33	28-pin DIP, SOIC, SSOP
PIC16C56	20	1K	—	25	TMR0	12	2.5-6.25	33	18-pin DIP, SOIC; 20-pin SSOP
PIC16C57	20	2K	—	72	TMR0	20	2.5-6.25	33	28-pin DIP, SOIC, SSOP
PIC16CR57B	20	—	2K	72	TMR0	20	2.5-6.25	33	28-pin DIP, SOIC, SSOP
PIC16C58A	20	2K	—	73	TMR0	12	2.0-6.25	33	18-pin DIP, SOIC; 20-pin SSOP
PIC16CR58A	20	—	2K	73	TMR0	12	2.5-6.25	33	18-pin DIP, SOIC; 20-pin SSOP

All PIC16/17 Family devices have Power-On Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

LIST OF TABLES

Note the following details of the code protection feature on PICmicro® MCUs.

- The PICmicro family meets the specifications contained in the Microchip Data Sheet.
- Microchip believes that its family of PICmicro microcontrollers is one of the most secure products of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the PICmicro microcontroller in a manner outside the operating specifications contained in the data sheet. The person doing so may be engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable”.
- Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our product.

If you have any further questions about this matter, please contact the local sales office nearest to you.

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